

Subject: Opening of price bid for Semi-Automatic Grinding-Polishing Machine for Metallographic Inspection.

Reference: Tender No. **RGIPT/Jais/R&D/SeedGrant-P-2108/e-open/2021-22/01**

The following Two Companies submitted their tenders for the above equipment before the due date-

1. CENSICO INTERNATIONAL (P) LTD. 5A, Mahatma Gandhi Road, Agra- 282002 (India)
2. CHENNAI METCO Pvt. Ltd C8, Ambattur Industrial Estate, Chennai – 600058

The technical bid of Semi-Automatic Grinding-Polishing Machine for Metallographic Inspection was opened and critically examined by the purchase committee constituted for the project sanctioned against faculty seed grant (P-2108). All the committee members are fully satisfied with the Technical Specifications given by the following two companies which covers all the technical specifications and terms & conditions mentioned in the tender documents.

1. CENSICO INTERNATIONAL (P) LTD. 5A, Mahatma Gandhi Road, Agra- 282002 (India)
2. CHENNAI METCO Pvt. Ltd C8, Ambattur Industrial Estate, Chennai –600058

Hence the committee certifies and recommends that the above two companies are technically qualified. It is decided to open the Price bid on 14th December 2021.

Purchase Committee

1. Dr. Deepak Dwivedi

: PI/Chairman

AM 10/12/2021

2. Dr. Amit Ranjan

: Ex-officio Member

Amit Ranjan - 10/12/2021

3. Dr. Vivek Kumar

: Member (Dean, R&D nominee)

Vivek
10/12/2021

4. Dr. Gunjan Kumar Agrahari

: Member

Gunjan
10/12/2021